### 502637340 01/15/2014

## PATENT ASSIGNMENT COVER SHEET

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| SUBMISSION TYPE:      | NEW ASSIGNMENT |
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| NATURE OF CONVEYANCE: | ASSIGNMENT     |

#### **CONVEYING PARTY DATA**

| Name         | Execution Date |
|--------------|----------------|
| JI-HYE MYUNG | 11/12/2013     |
| HYE-MI LEE   | 11/12/2013     |

#### RECEIVING PARTY DATA

| Name:  | SAMSUNG ELECTRONICS CO., LTD. |  |
|--|-------------------------------|--|
| Street Address: 129, SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO 443-742 |                               |  |
| City:  | SUWON-SI                      |  |
| State/Country:   | KOREA, REPUBLIC OF            |  |

#### PROPERTY NUMBERS Total: 1

| Property Type       | Number   |
|---------------------|----------|
| Application Number: | 29476216 |

#### CORRESPONDENCE DATA

 Fax Number:
 (202)315-3758

 Phone:
 2024290020

 Email:
 pto@nsiplaw.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: NSIP LAW
Address Line 1: PO BOX 65745

Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20035

| ATTORNEY DOCKET NUMBER: | D91111.0137        |
|-------------------------|--------------------|
| NAME OF SUBMITTER:      | SHABNAM NOWROUZI   |
| Signature:              | /Shabnam Nowrouzi/ |
| Date:                   | 01/15/2014         |

Total Attachments: 2

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PATENT REEL: 031978 FRAME: 0437

# COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

# DECLARATION

| As a below-named inventor, I hereby declare that the  | nis declaration is directed to the application attached  |
|---|--|
| hereto, or to United States Application Number or I   | CT International Application Number  |
| filed on  | (if applicable), entitled:   |
| DISPLAY SCREEN OR POR   | TION THEREOF WITH ICON   |
| The above-identified application was made or authorized   | orized to be made by me.   |
| I believe I am the original inventor or an original jound identified application.                                     | int inventor of a claimed invention in the above-  |
| I hereby acknowledge that any willful false stateme<br>USC 1001 by fine or imprisonment of not more tha               |  |
| I have reviewed and understand the contents of the  | above-identified application, including the claims.  |
|   | ed in 37 CFR 1.56, including for continuation-in-part lable between the filing date of the prior application |
| ASSIG   | NMENT  |
| For valuable consideration, I, as a below-named ass   | ignor, hereby assign to:   |
| Samsung Electronics Co., Ltd.<br>129, Samsung-ro, Yeongtong-gu<br>Suwon-si, Gyconggi-do, 443-742<br>Republic of Korea |  |
| and its successors and assigns (collectively hereinal   | ter called "the Assignee"), the entire right, title, and   |
| interest throughout the world in the inventions and   | improvements that are the subject of the application   |
| identified in the above declaration, which is United Application Number29/476,216                                     |  |
|   |  |

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I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-identified

application when known, and to correct any typographical errors that may be discovered in this Assignment.

This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

| Inventor's Legal Name        | Ji-Hye MYUNG   | *************************************** |       |
|------------------------------|--|---|-------|
| Inventor's Signature         |  | Date                                    | (1.12 |
| Residence (City,<br>Country) | Yongin-si, Republic of Korea   |   |       |
| Mailing Address              | 110-101, Pureunsol Sinil Apt., 184, Guseong-ro, Giheung-gu, Yongin-si.<br>446-943 Gyeonggi-do, Republic of Korea |   |       |

| a                                       | Inventor's Legal Name        | Hye-Mi LEE  |      |                           |
|---|------------------------------|---|------|---------------------------|
|   | Inventor's Signature         | (dyenni   | Date | 11 , 12                   |
| *************************************** | Residence (City,<br>Country) | Incheon, Republic of Korea  502-204, Jugong Mirae Town 5-danji, 16, Yeongscongjung-ro, Bupye gu, 403-758 Incheon, Republic of Korea |      |                           |
| ***********                             | Mailing Address              |   |      | ngseongjung-ro, Bupyeong- |

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